

Automotive Dual N-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	60
$R_{DS(on)}$ (Ω) at $V_{GS} = 10$ V	0.055
I_D (A)	4.5
Configuration	Dual

FEATURES

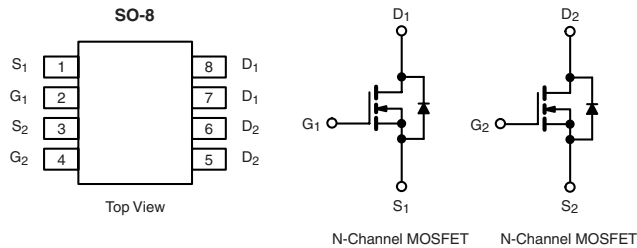
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance

AEC-Q101 RELIABILITY

- Passed all AEC-Q101 Reliability Testing
- Characterization Ongoing



Available
RoHS*
COMPLIANT



ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free	SQ4946EY-T1-E3
SnPb	SQ4946EY-T1

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^a	I_D	$T_C = 25$ °C	A
		$T_C = 70$ °C	
Continuous Source Current (Diode Conduction) ^a	I_S	2	A
Pulsed Drain Current ^b	I_{DM}	30	
Single Pulse Avalanche Energy	E_{AS}	7.2	
Single Pulse Avalanche Current	I_{AS}	12	A
Maximum Power Dissipation ^b	P_D	$T_C = 25$ °C	W
		$T_A = 70$ °C	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient	R_{thJA}	62.5	°C/W
Junction-to-Case (Drain)	R_{thJC}	-	

Notes

- Package limited.
- Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %.
- When mounted on 1" square PCB (FR-4 material).

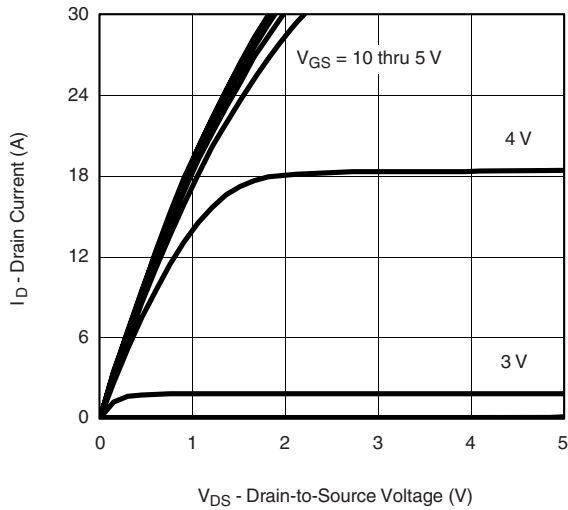
SPECIFICATIONS $T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$	-	-	-	V
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	1.0	-	3.0	
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0\text{ V}$ $V_{DS} = 60\text{ V}$	-	-	2.0	μA
		$V_{GS} = 0\text{ V}$ $V_{DS} = 60\text{ V}$, $T_J = 55\text{ }^\circ\text{C}$	-	-	25	
		$V_{GS} = 0\text{ V}$ $V_{DS} = 60\text{ V}$, $T_J = 175\text{ }^\circ\text{C}$	-	-	-	
On-State Drain Current ^a	$I_{D(on)}$	$V_{GS} = 10\text{ V}$ $V_{DS} \geq 5\text{ V}$	20	-	-	A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$ $I_D = 4.5\text{ A}$	-	0.045	0.055	Ω
		$V_{GS} = 10\text{ V}$ $I_D = 30\text{ A}$, $T_J = 125\text{ }^\circ\text{C}$	-	-	-	
		$V_{GS} = 10\text{ V}$ $I_D = 30\text{ A}$, $T_J = 175\text{ }^\circ\text{C}$	-	-	-	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\text{ V}$, $I_D = 4.5\text{ A}$	-	13	-	S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{ V}$ $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	-	-	-	pF
Output Capacitance	C_{oss}		-	-	-	
Reverse Transfer Capacitance	C_{rss}		-	-	-	
Total Gate Charge ^c	Q_g	$V_{GS} = 10\text{ V}$ $V_{DS} = 30\text{ V}$, $I_D = 4.5\text{ A}$	-	19	30	nC
Gate-Source Charge ^c	Q_{gs}		-	4	-	
Gate-Drain Charge ^c	Q_{gd}		-	3	-	
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 30\text{ V}$, $R_L = 30\text{ }\Omega$ $I_D \cong 1\text{ A}$, $V_{GEN} = 10\text{ V}$, $R_g = 6\text{ }\Omega$	-	13	20	ns
Rise Time ^c	t_r		-	11	20	
Turn-Off Delay Time ^c	$t_{d(off)}$		-	36	60	
Fall Time ^c	t_f		-	11	20	
Source-Drain Diode Ratings and Characteristics $T_C = 25\text{ }^\circ\text{C}$ ^b						
Pulsed Current ^a	I_{SM}		-	-	-	A
Forward Voltage	V_{SD}	$I_F = 85\text{ A}$, $V_{GS} = 0\text{ V}$	-	-	-	V
Reverse Recovery Time	t_{rr}	$I_F = 2\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$	-	35	60	ns
Peak Reverse Recovery Current	$I_{RM(REC)}$		-	-	-	A
Reverse Recovery Charge	Q_{rr}		-	-	-	μC

Notes

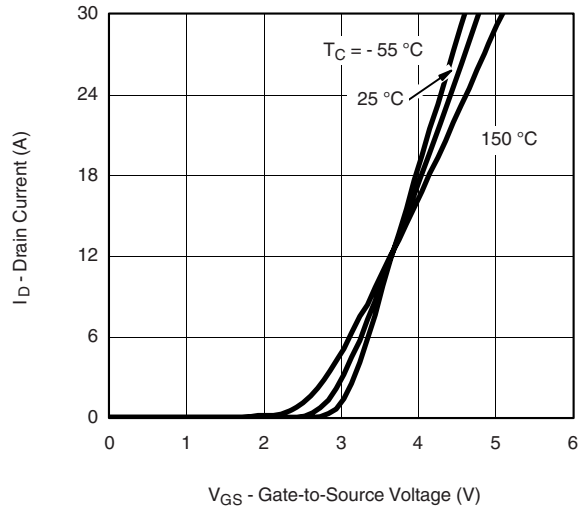
- Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

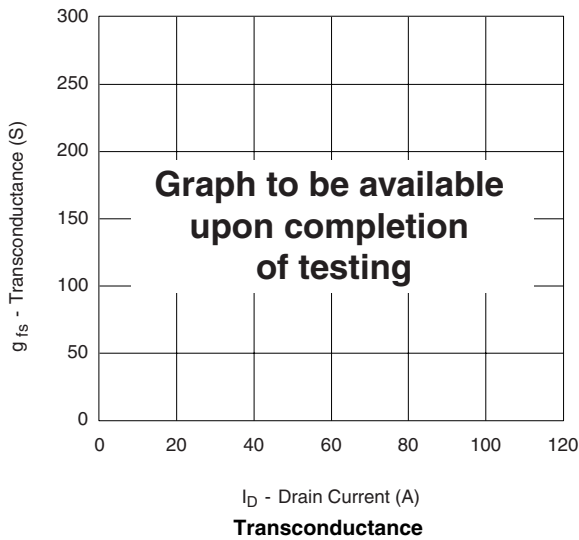
TYPICAL CHARACTERISTICS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



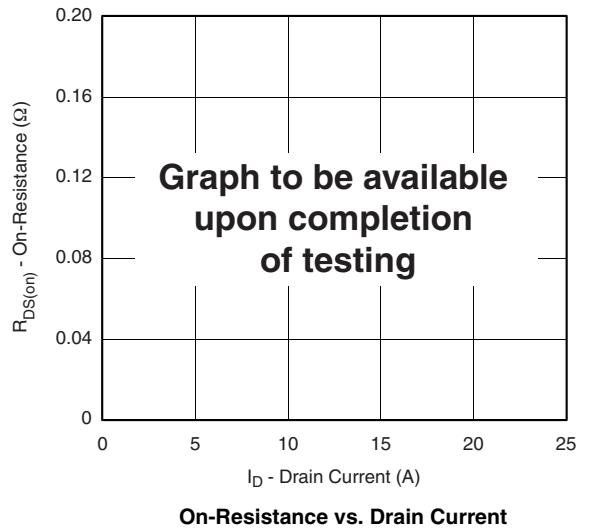
V_{DS} - Drain-to-Source Voltage (V)
Output Characteristics



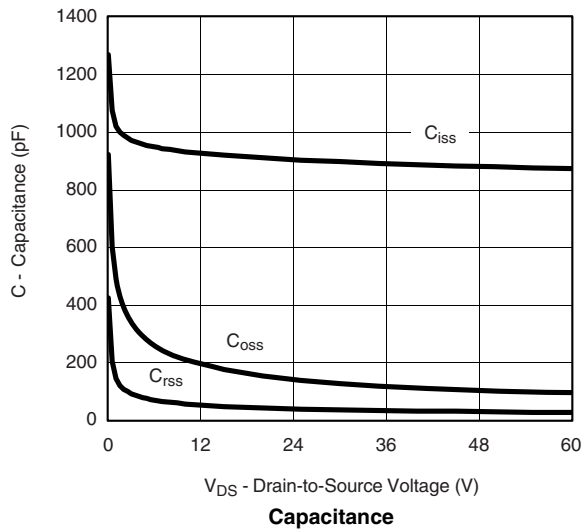
V_{GS} - Gate-to-Source Voltage (V)
Transfer Characteristics



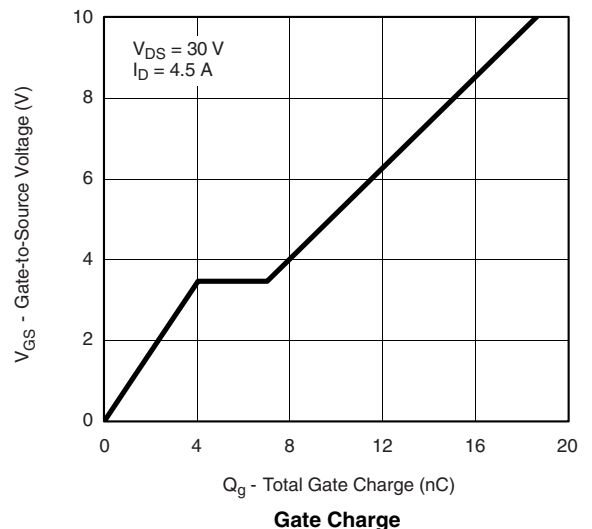
I_D - Drain Current (A)
Transconductance



On-Resistance vs. Drain Current

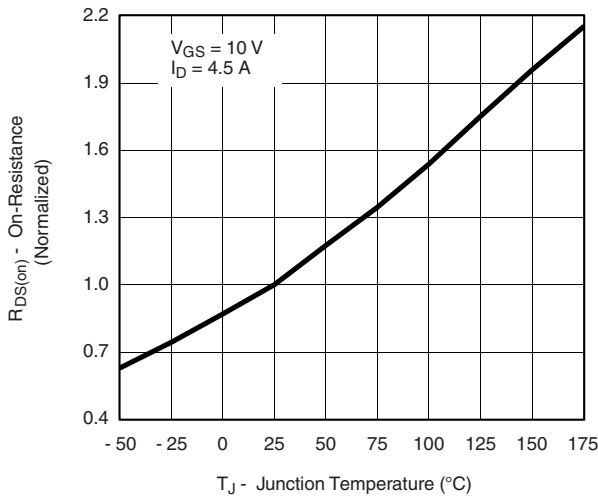


Capacitance

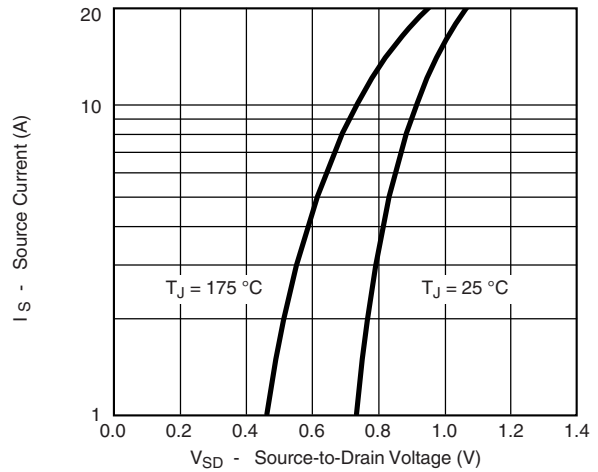


Gate Charge

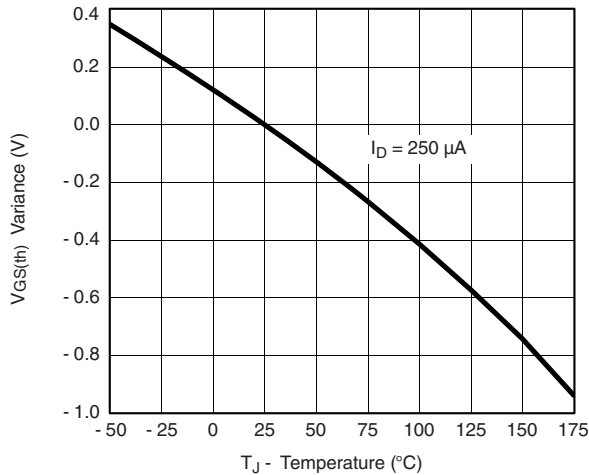
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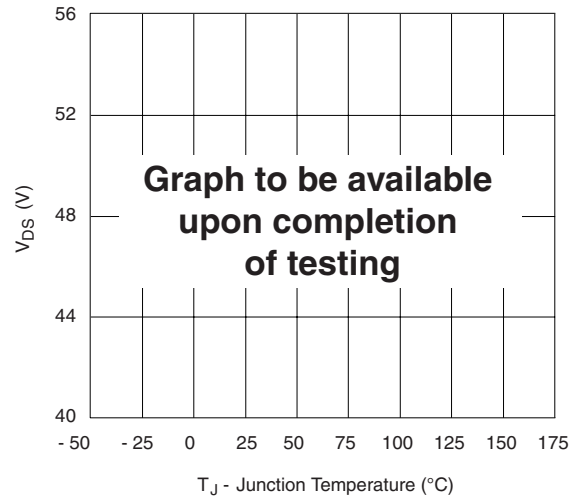
On-Resistance vs. Junction Temperature



Source Drain Diode Forward Voltage

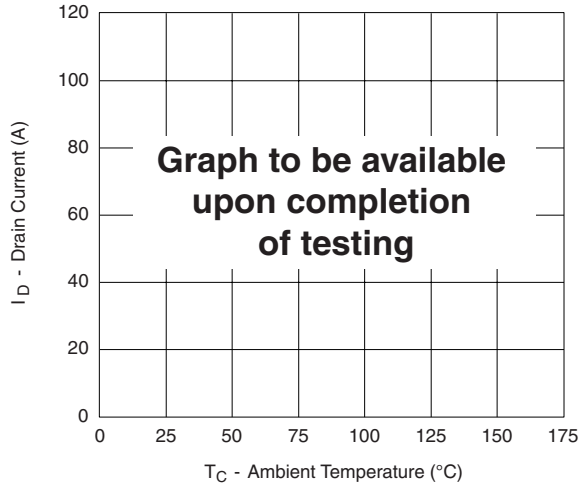


On-Resistance vs. Gate-to-Source Voltage

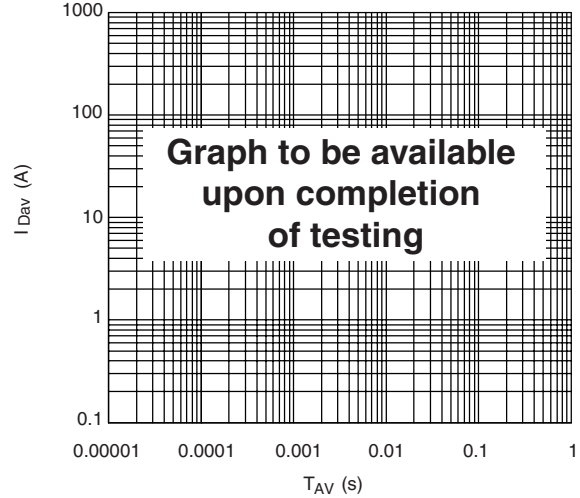


Drain Source Breakdown vs. Junction Temperature

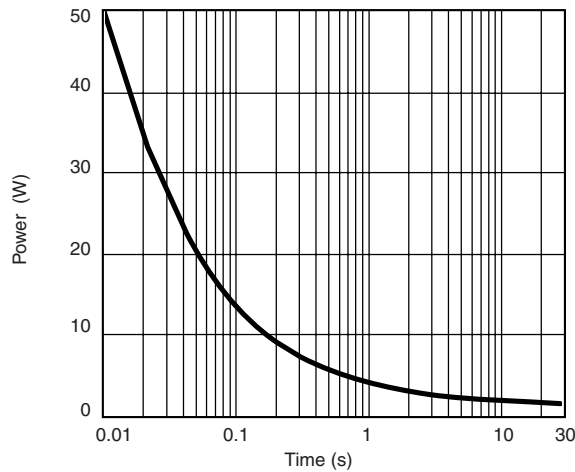
THERMAL RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



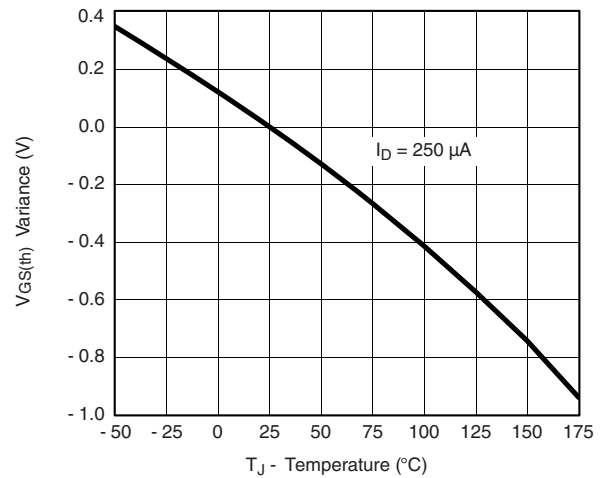
Maximum Drain Current vs. Ambient Temperature



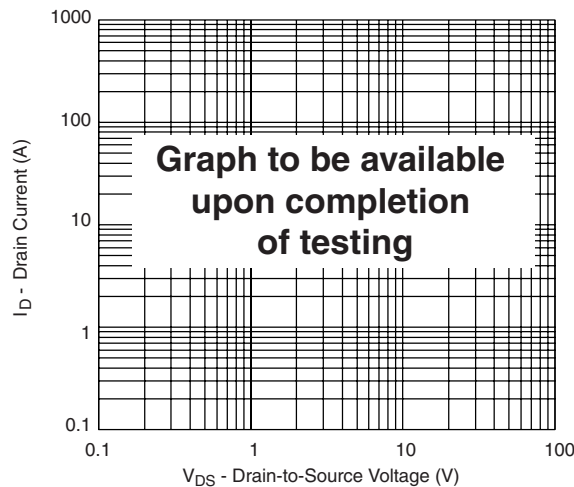
Avalanche Current vs. Time



Single Pulse Power, Junction-to-Ambient



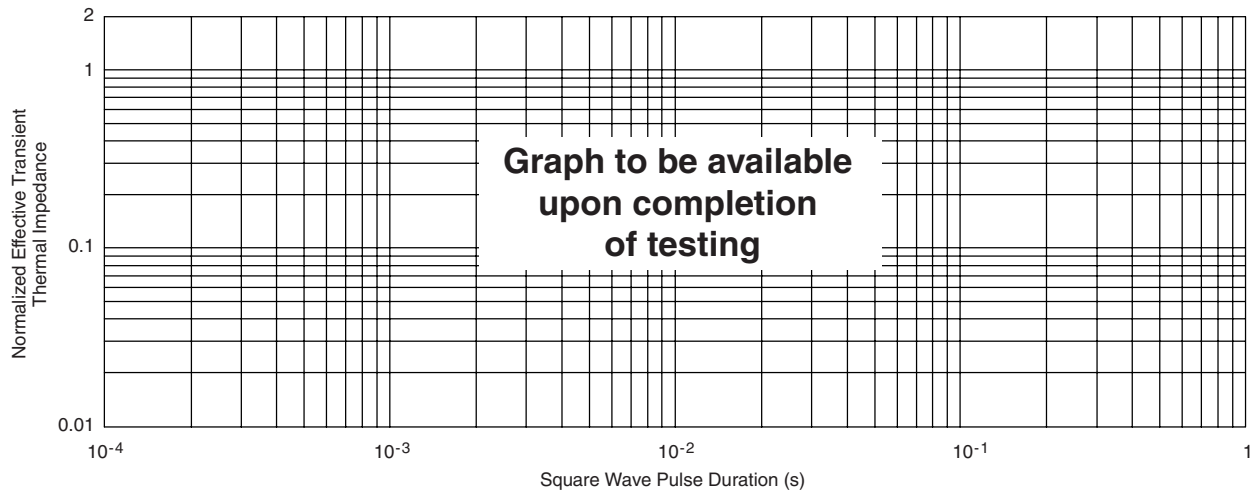
Threshold Voltage



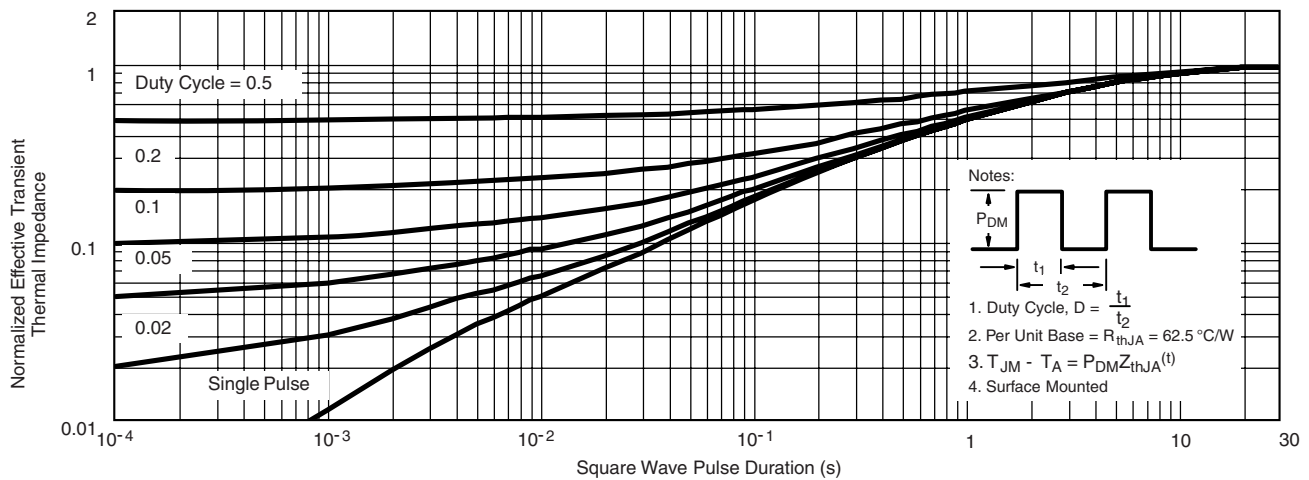
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area

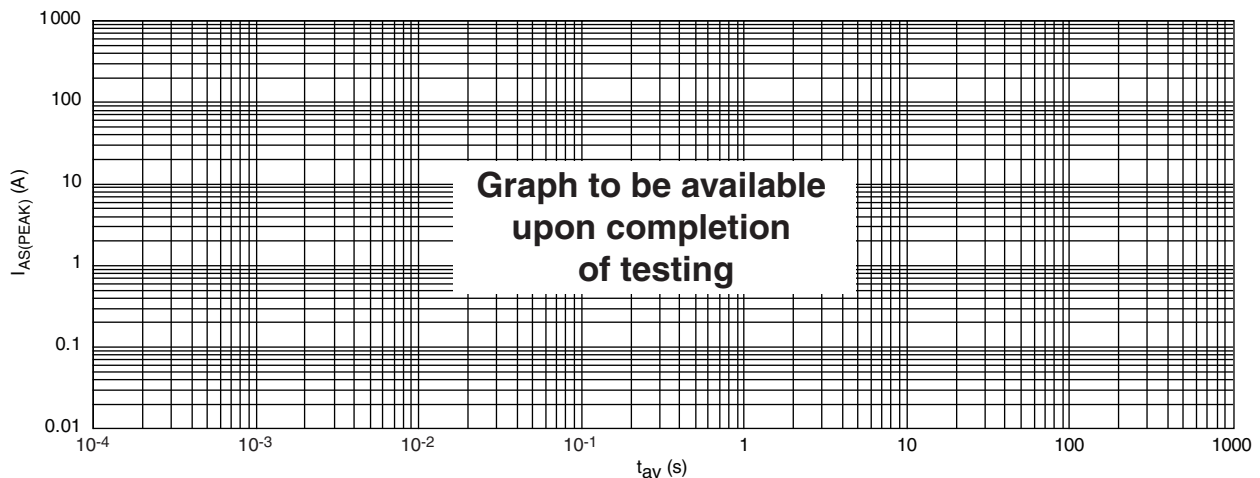
THERMAL RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

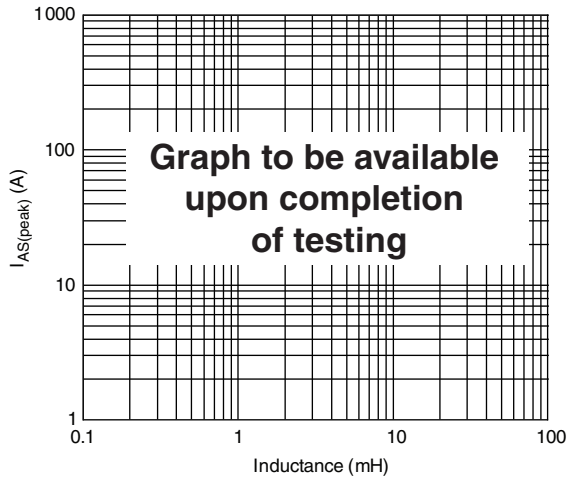


Normalized Thermal Transient Impedance, Junction-to-Ambient

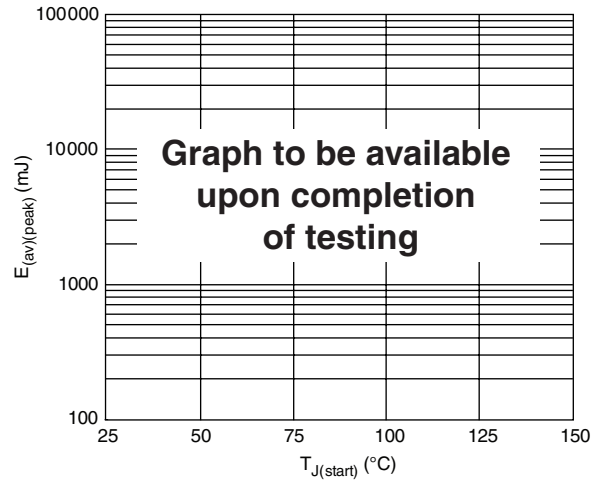


Single Pulse Avalanche Current (Peak) vs. Time in Avalanche

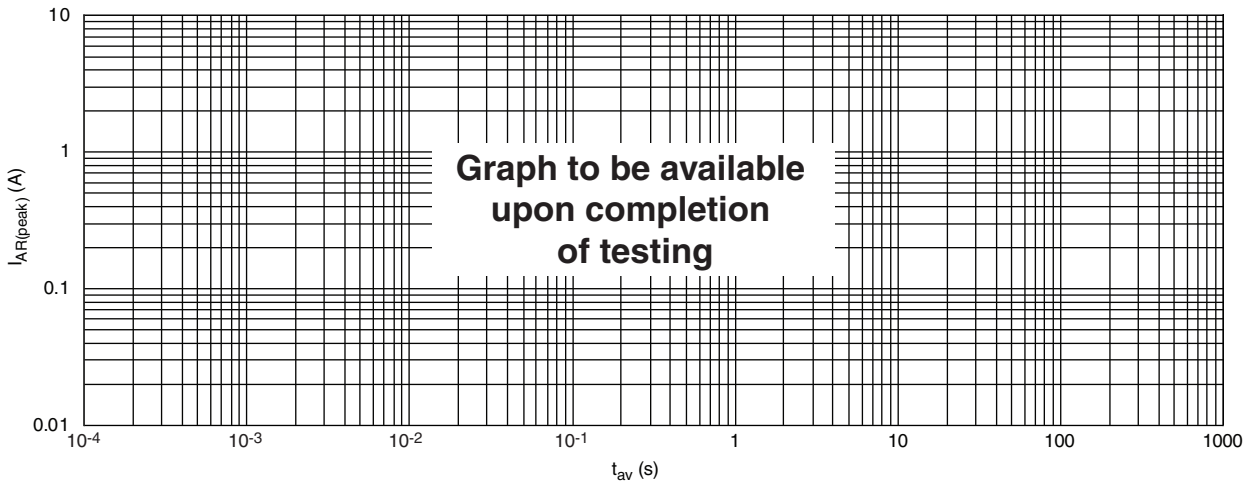
THERMAL RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



Single Pulse Avalanche Current (Peak) vs. Inductance

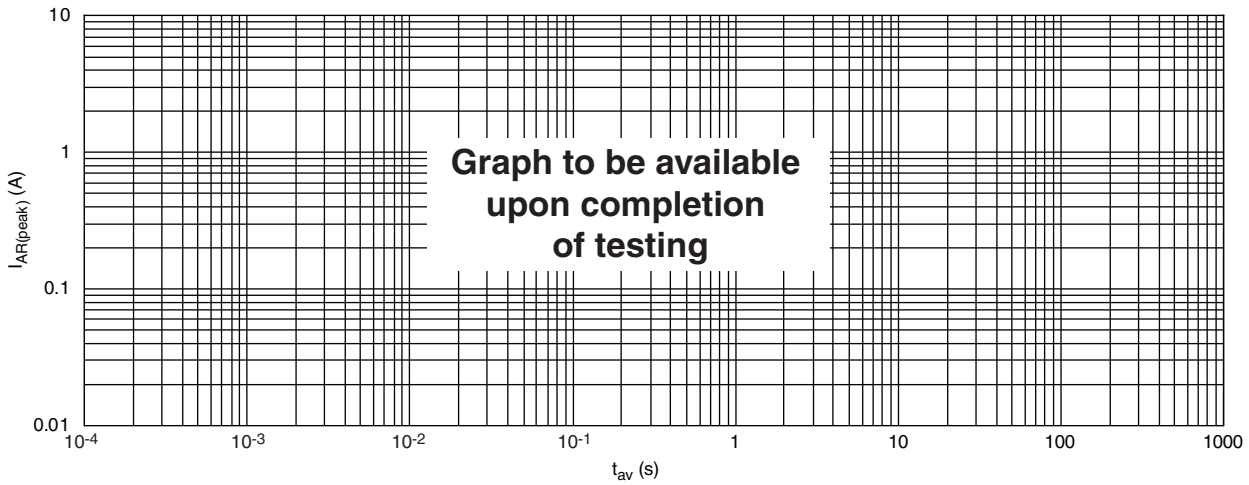


Single Pulse Avalanche Energy (Peak) vs. $T_{J(start)}$



Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 25\text{ }^\circ\text{C}$

THERMAL RATINGS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 150\text{ }^\circ\text{C}$

Note

The characteristics shown in the six graphs

- Normalized Transient Thermal Impedance Junction to Ambient ($25\text{ }^\circ\text{C}$)
- Single Pulse Avalanche Current (Peak) vs. Time in Avalanche
- Single Pulse Avalanche Current (Peak) vs. Inductance
- Single Pulse Avalanche Energy (Peak) vs. $T_{J(\text{start})}$
- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 25\text{ }^\circ\text{C}$
- Repetitive Avalanche Current (Peak) vs. Time in Avalanche at $T_A = 150\text{ }^\circ\text{C}$

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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